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February 1998

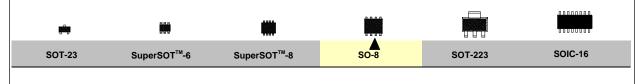
FDS8926A Dual N-Channel Enhancement Mode Field Effect Transistor

General Description

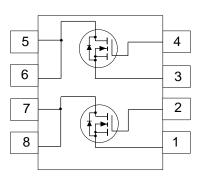
SO-8 N-Channel enhancement mode power field effect transistors are produced using Fairchild's proprietary, high cell density, DMOS technology. This very high density process is especially tailored to provide superior switching performance and minimize on-state resistance. These devices are particularly suited for low voltage applications such as disk drive motor control, battery powered circuits where fast switching, low in-line power loss, and resistance to transients are needed.

Features

- High density cell design for extremely low R_{DS(ON)}.
- Combines low gate threshold (fully enhanced at 2.5V) with high breakdown voltage of 30 V.
- High power and current handling capability in a widely used surface mount package.
- Dual MOSFET in surface mount package.







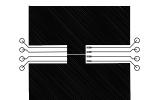
Absolute Maximum Ratings $T_A = 25^{\circ}C$ unless other wise noted

Symbol	Parameter	FDS8926A	Units
V _{DSS}	Drain-Source Voltage	30	V
V _{GSS}	Gate-Source Voltage	±8	V
I _D	Drain Current - Continuous (Note 1a)	5.5	А
	- Pulsed	20	
P _D	Power Dissipation for Dual Operation	2	W
	Power Dissipation for Single Operation (Note 1a)	1.6	
	(Note 1b)	1	
	(Note 1c)	0.9	
T_,T _{stg}	Operating and Storage Temperature Range	-55 to 150	°C
THERMA	L CHARACTERISTICS		•
R _{eja}	Thermal Resistance, Junction-to-Ambient (Note 1a)	78	°C/W
R _{euc}	Thermal Resistance, Junction-to-Case (Note 1)	40	°C/W

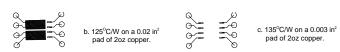
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Symbol	Parameter	Conditions	Min	Тур	Max	Units
OFF CHAR	ACTERISTICS	· ·				•
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$	30			V
$\Delta BV_{DSS} / \Delta T_{J}$	Breakdown Voltage Temp. Coefficient	$I_{\rm D}$ = 250 µA, Referenced to 25°C		32		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\rm DS} = 24 \text{V}, V_{\rm GS} = 0 \text{V}$			1	μA
		T _J = 55°C			10	μA
	Gate - Body Leakage, Forward	V _{GS} = 8 V, V _{DS} = 0 V			100	nA
I _{GSSR}	Gate - Body Leakage, Reverse	$V_{GS} = -8 V, V_{DS} = 0 V$			-100	nA
ON CHARA	CTERISTICS (Note 2)	· · ·				•
V _{GS(th)}	Gate Threshold Voltage	$V_{\rm DS} = V_{\rm GS}, \ I_{\rm D} = 250 \ \mu {\rm A}$	0.4	0.67	1	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	$I_D = 250 \ \mu\text{A}$, Referenced to 25°C		-3		mV /°C
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 5.5 \text{ A}$		0.025	0.03	Ω
-(-)		T _J =125°C		0.037	0.052	
		$V_{GS} = 2.5 \text{ V}, \text{ I}_{D} = 4.5 \text{ A}$		0.031	0.038	
I _{D(ON)}	On-State Drain Current	$V_{GS} = 4.5 \text{ V}, V_{DS} = 5 \text{ V}$	20			А
9 _{FS}	Forward Transconductance	$V_{\rm DS} = 5 \text{V}, \text{I}_{\rm D} = 5.5 \text{A}$		20		S
DYNAMIC (CH ARACTERISTICS	· ·				•
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz		900		pF
C _{oss}	Output Capacitance	f = 1.0 MHz		410		pF
C _{rss}	Reverse Transfer Capacitance			110		pF
SWITCHING	CHARACTERISTICS (Note 2)					
t _{D(on)}	Turn - On Delay Time	$V_{DS} = 6 V, I_{D} = 1 A$		6	12	ns
t,	Turn - On Rise Time	$V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		19	31	
t _{D(off)}	Turn - Off Delay Time			42	67	
t,	Turn - Off Fall Time			13	24	
Q _g	Total Gate Charge	$V_{\rm DS} = 10 \text{ V}, \ I_{\rm D} = 5.5 \text{ A},$		19.8	28	nC
Q _{gs}	Gate-Source Charge			2		
Q _{gd}	Gate-Drain Charge			6.3		
DRAIN-SOU	IRCE DIODE CHARACTERISTICS AND MA	XIMUM RATINGS	_		-	
I _s	Maximum Continuous Drain-Source Diode F	orward Current			1.3	А
V _{SD}	Drain-Source Diode Forward Voltage	$V_{GS} = 0 V, I_{S} = 1.3 A$ (Note 2)		0.68	1.2	V

1. R_{BA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{BAC} is guaranteed by design while $\mathsf{R}_{_{\theta^{CA}}}$ is determined by the user's board design.

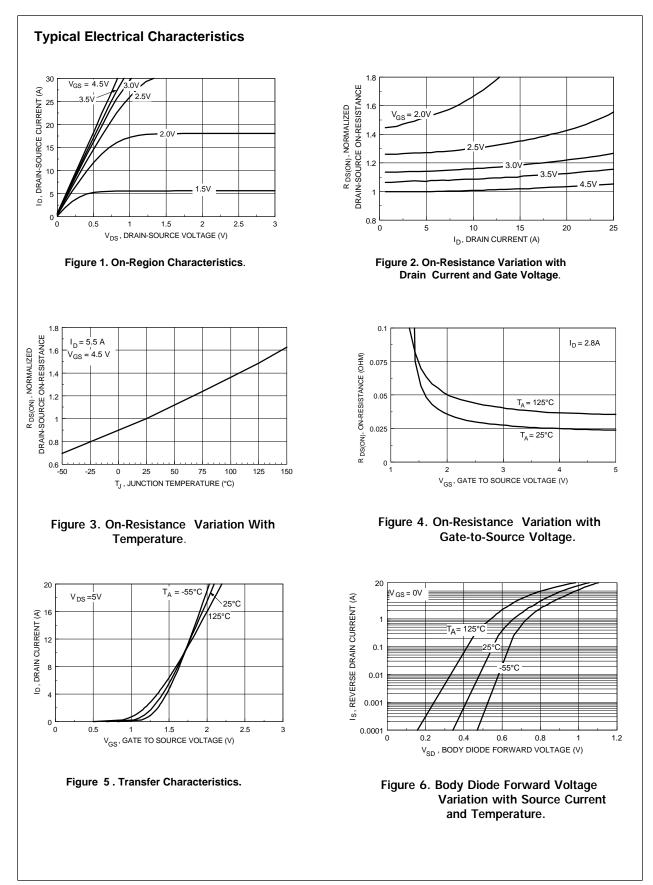


a. 78°C/W on a 0.5 in² pad of 2oz copper.

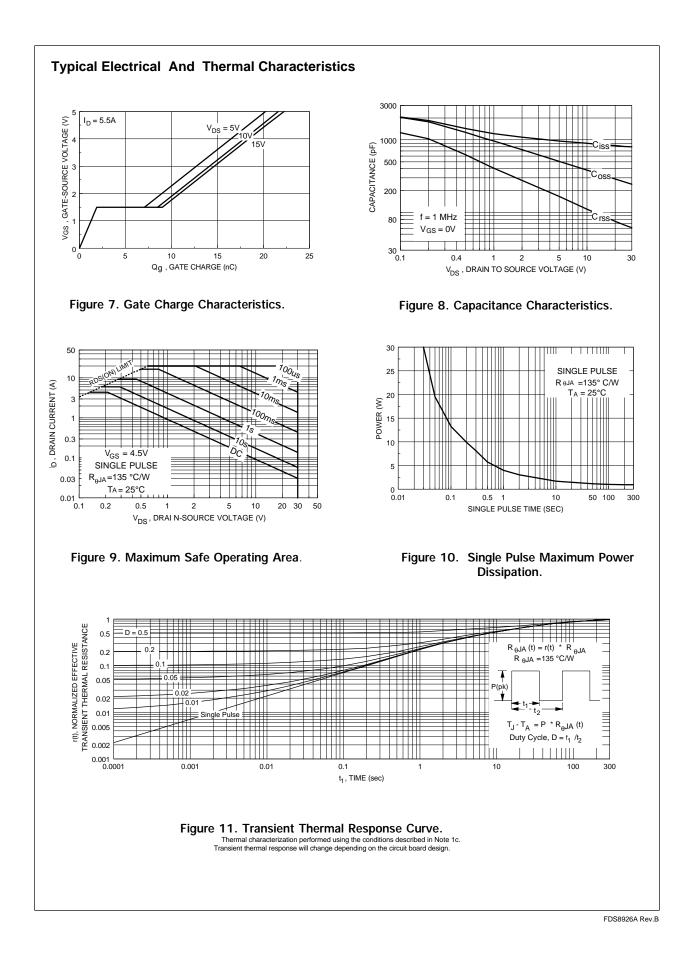


Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.



FDS8926A Rev.B



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